



Horizontal Desmear/PTH | 水平去胶渣/化学沉铜

CIRCUPOSIT™ 4000 Horizontal Desmear / PTH

Advantages 优点

- Capable of conveying thin boards (thickness: 50 µm)
适用于薄板(厚度: 50µm)连续生产
- High productivity due to shortened processing time
较短的反应时间可以提高产量
- Improvement of working environment from closed system
密闭式反应改善工作环境
- Applicable to wide variety of resin such as FR-4, High Tg, and polyimide
可应用于不同的树脂材料,如FR-4, High Tg, 和 polyimide

Characterization 特性描述



Excellent coverage in microvia
深盲孔优异的镀层覆盖能力

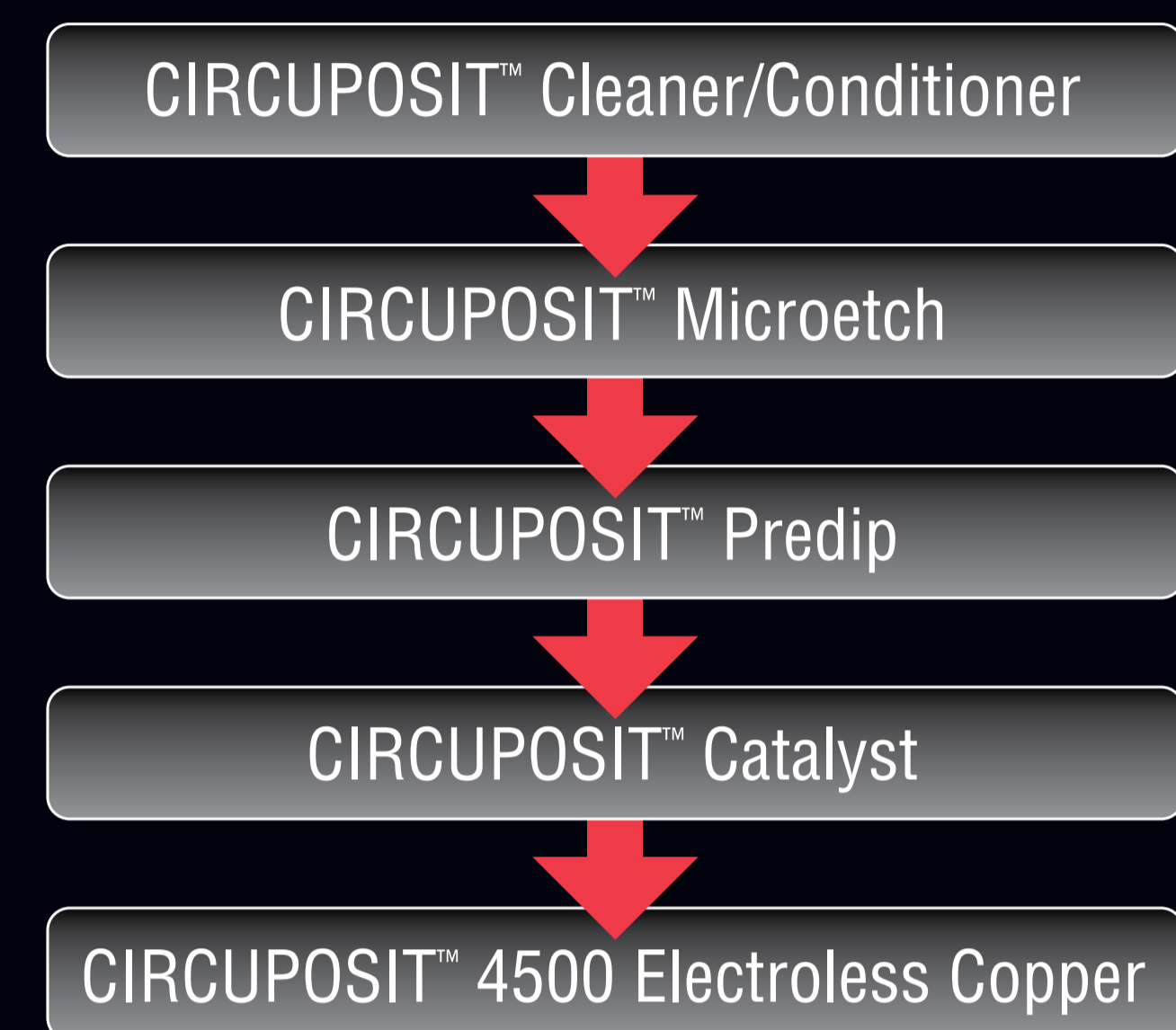


Excellent glass fiber coverage and ultra fine grain structure
优异的玻纤覆盖能力及细致的化铜沉积



Ultimate in PTH reliability
优异的化铜信赖性

Process 制程

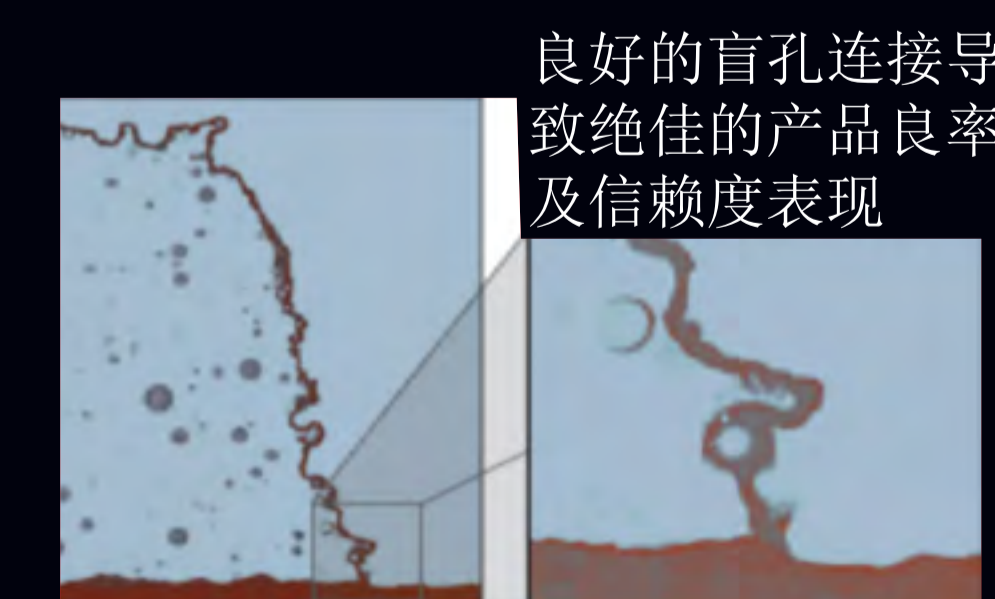
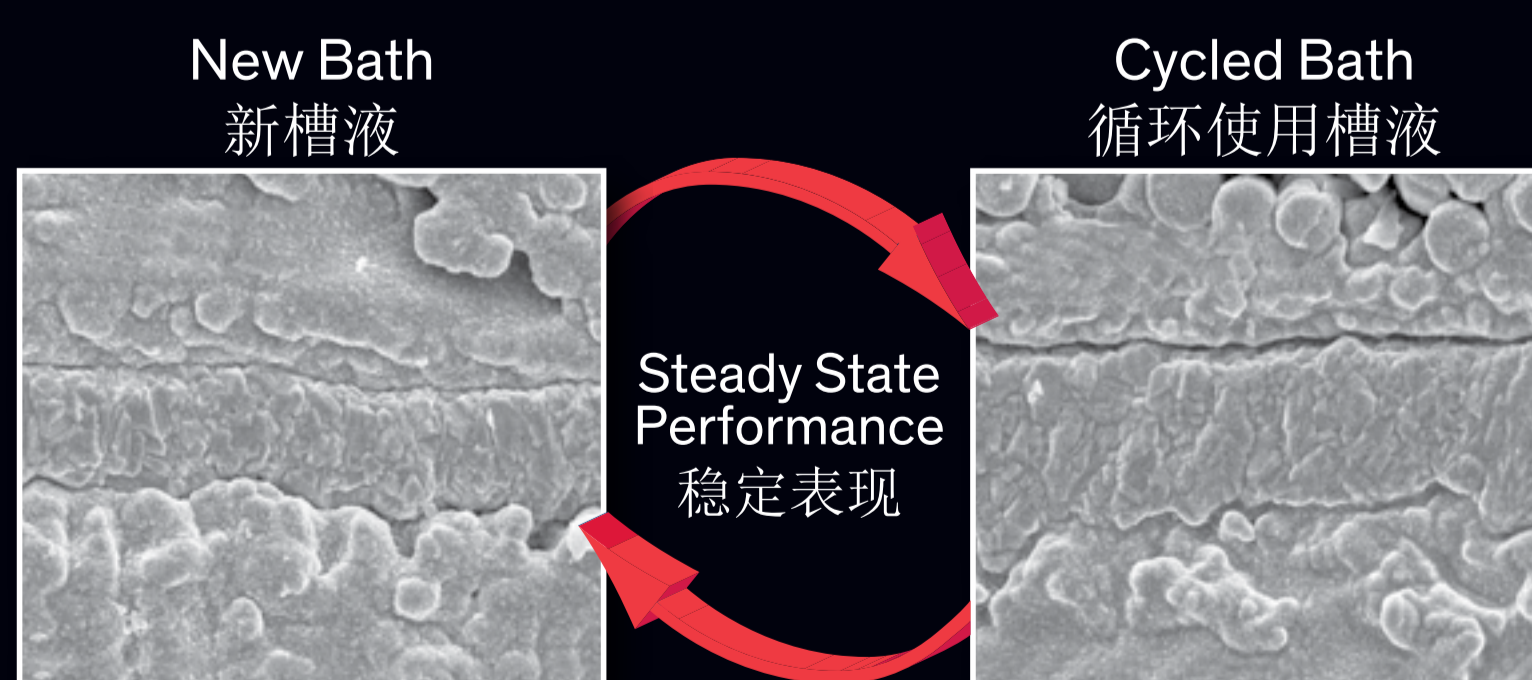
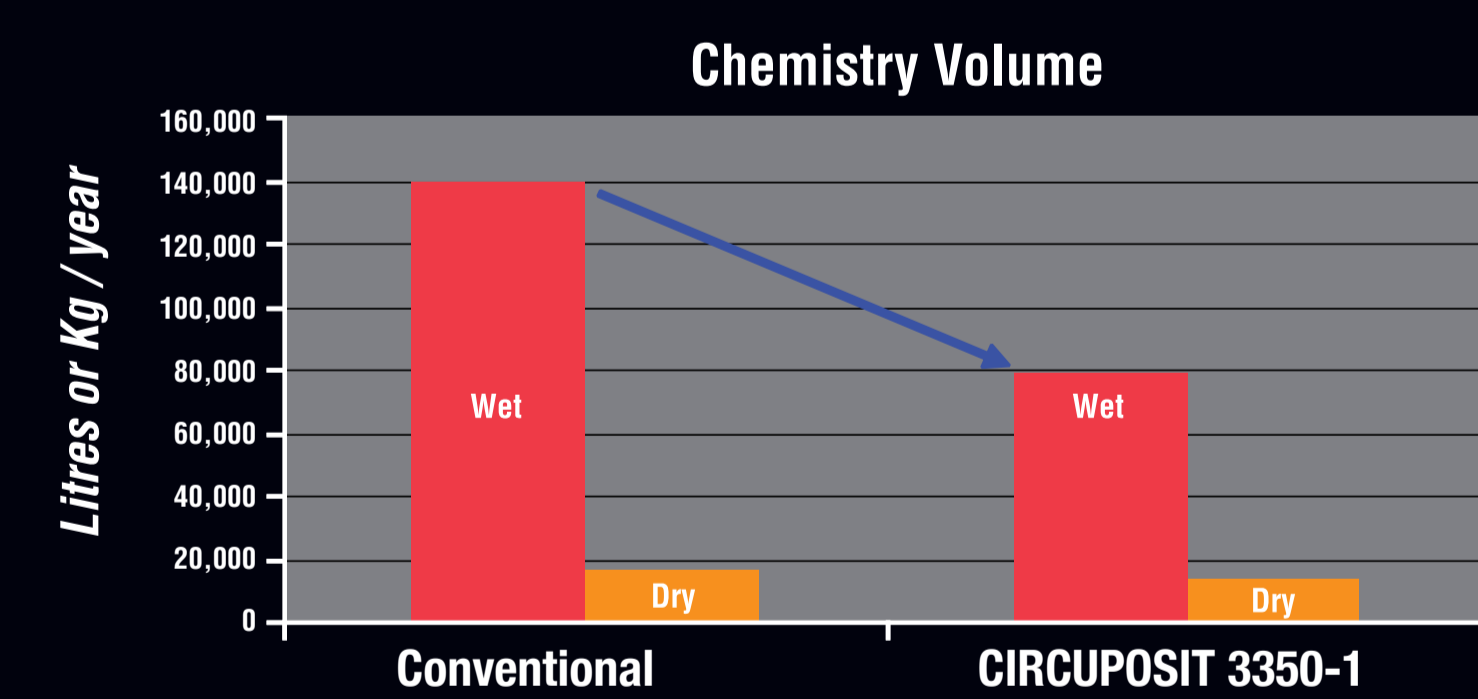


Universal Electroless Copper | 泛用型化学沉铜

CIRCUPOSIT™ 3350-1 Electroless Copper

Features and Benefits 特长及优点

- An universal electroless copper process
可被广泛应用于各式设备之化学铜制程
- Reduce chemistry volumes
减少药液使用量
- Reduce catalyst strength
减少催化剂药液强度
- Steady state operation
槽液操作稳定
- Exceptional performance and reliability
具有卓越的产品表现及信赖性
- Global customer reference list
客户遍及全球



良好的盲孔连接导致绝佳的产品良率及信赖度表现

